OKI Open up your dreams

OKI Semiconductor

FEDR26V6455J-02-01
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MR26V6455J

2M–Word × 32–Bit or 4M–Word × 16–Bit Page Mode P2ROM

FEATURES

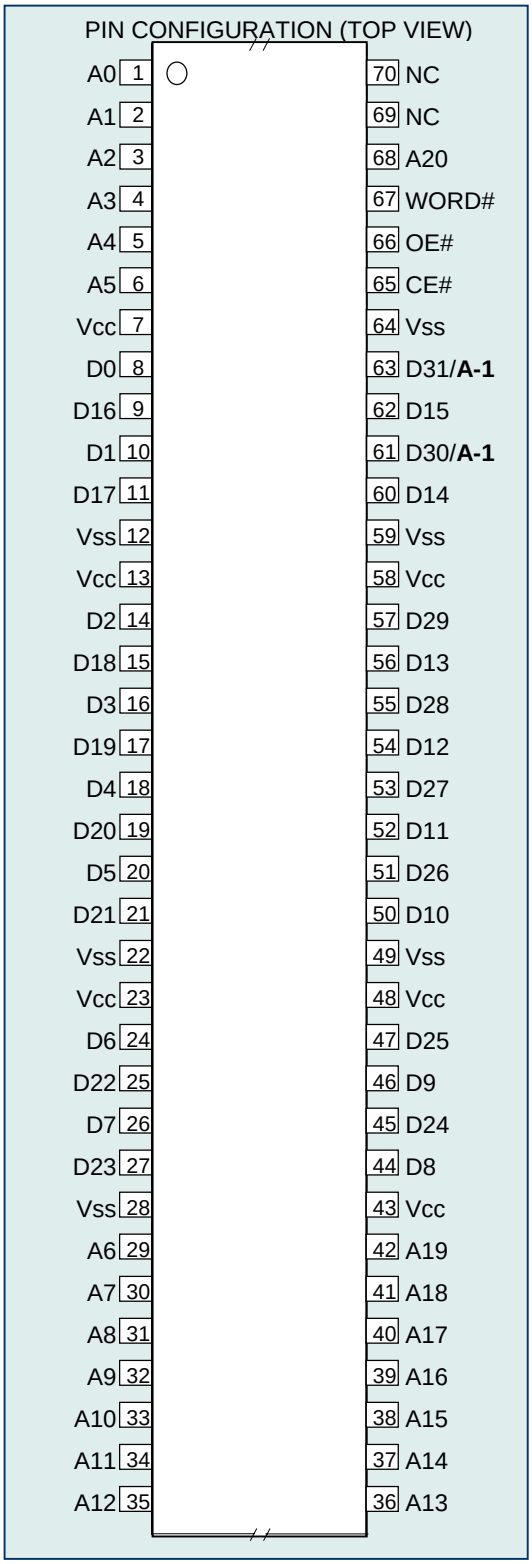
· 2,097,152-word × 32-bit / 4,194,304-word × 16-bit electrically switchable configuration
· Page size of 8-word x 32-Bit or 16-word x 16-Bit
· 3.0 V to 3.6 V power supply
·Random Access time 100 ns MAX
·Page Access time 30ns MAX
· Operating current 100 mA MAX
· Standby current 20 µA MAX

· Input/Output TTL compatible
· Three-state output

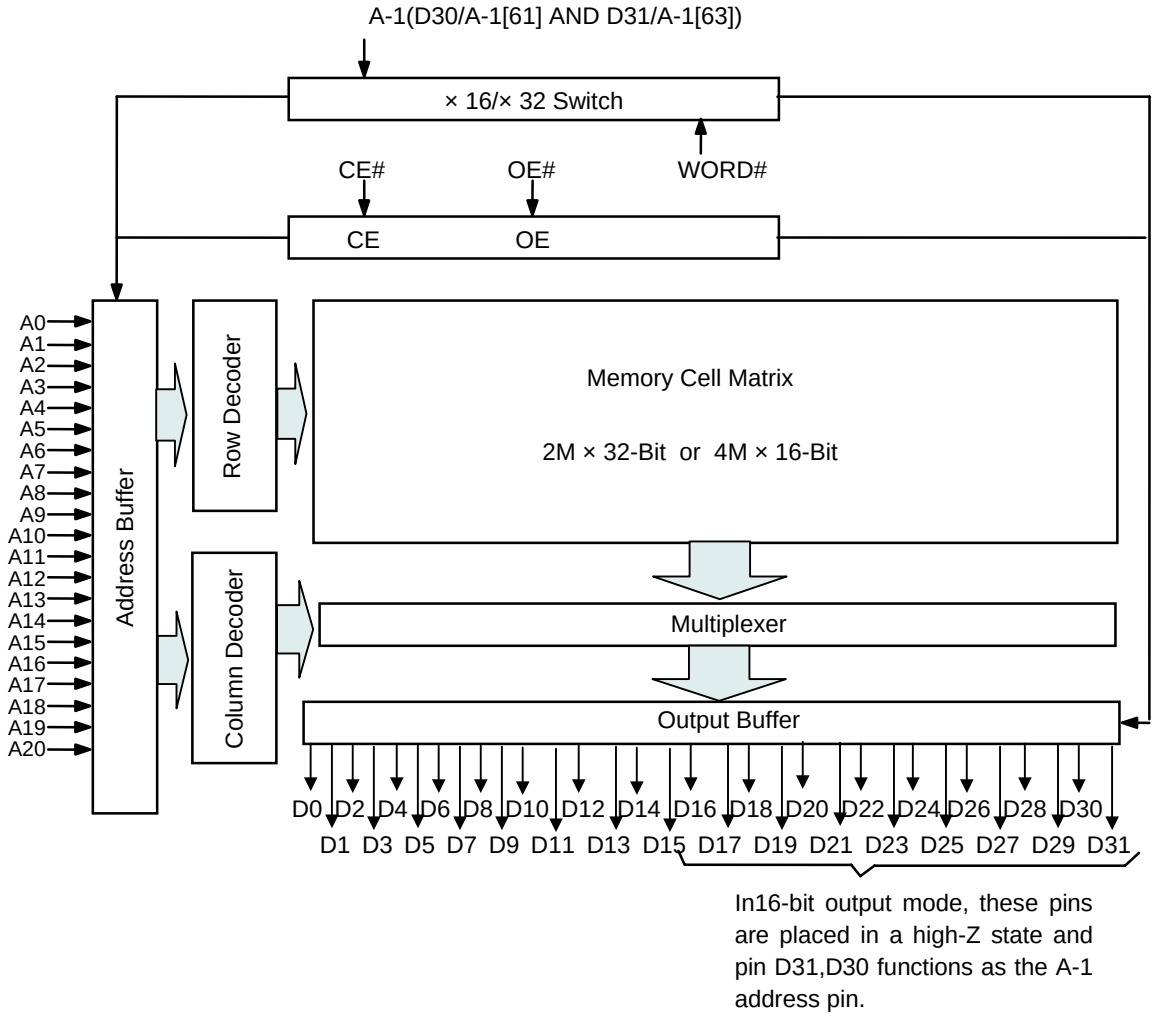
PACKAGES

· MR26V6455J-xxxMB
70-pin plastic SSOP (P-SSOP70-500-0.80-K-MC)

PIN CONFIGURATION (TOP VIEW)



BLOCK DIAGRAM



PIN DESCRIPTIONS

Pin name	Functions
D31 / A-1,D30/A-1	Data output / Address input
A0 to A20	Address inputs
D0 to D29	Data outputs
CE#	Chip enable input
OE#	Output enable input
WORD#	Word -Byte select input
V_{CC}	Power supply voltage
V_{SS}	Ground

FUNCTION TABLE

Mode	CE#	OE#	WORD#	V_{CC}	D0 to D15	D16 to D29	D30/A–1,D31/A-1
Read (32-Bit)	L	L	H	3.3 V	D_{OUT}		
Read (16Bit)	L	L	L		D_{OUT}	Hi–Z	L/H
Output disable	L	H	H		Hi–Z		
			L				*
Standby	H	*	H		Hi–Z		
			L				*

*: Don't Care (H or L)

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Ta	—	0 to 70	°C
Storage temperature	Tstg		–55 to 125	°C
Input voltage	V_I	relative to V_{SS}	–0.5 to V_{CC}+0.5	V
Output voltage	V_O		–0.5 to V_{CC}+0.5	V
Power supply voltage	V_{CC}		–0.5 to 5	V
Power dissipation per package	P_D	Ta = 25°C	1.0	W
Output short circuit current	I_{OS}	—	10	mA

RECOMMENDED OPERATING CONDITIONS

(Ta = 0 to 70°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
V_{CC} power supply voltage	V_{CC}	V_{CC} = 3.0 to 3.6 V	3.0	—	3.6	V
Input "H" level	V_{IH}		2.2	—	V_{CC}+0.5*	V
Input "L" level	V_{IL}		–0.5**	—	0.6	V

Voltage is relative to V_{SS}.

* : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.

** : -1.5V(Min.) when pulse width of undershoot is less than 10ns.

PIN CAPACITANCE

(V_{CC} = 3.3 V, Ta = 25°C, f = 1 MHz)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input	C_{IN1}	V_I = 0 V	—	—	20	pF
WORD#	C_{IN2}		—	—	400	
Output	C_{OUT}	V_O = 0 V	—	—	20	

ELECTRICAL CHARACTERISTICS

DC Characteristics

(V_{CC} = 3.3 V ± 0.3 V, Ta = 0 to 70°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I_{LI}	V_I = 0 to V_{CC}	—	—	10	µA
Output leakage current	I_{LO}	V_O = 0 to V_{CC}	—	—	10	µA
V_{CC} power supply current (Standby)	I_{CCSC}	CE# = V_{CC}	—	—	20	µA
	I_{CCST}	CE# = V_{IH}	—	—	1	mA
V_{CC} power supply current (Read)	I_{CCA1}	CE# = V_{IL}, OE#= V_{IH}, tc = 5MHz	—	—	100	mA
Input "H" level	V_{IH}	—	2.2	—	V_{CC}+0.5*	V
Input "L" level	V_{IL}	—	–0.5**	—	0.6	V
Output "H" level	V_{OH}	I_{OH} = –2 mA	2.4	—	—	V
Output "L" level	V_{OL}	I_{OL} = 2 mA	—	—	0.4	V

Voltage is relative to V_{SS}.

* : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.

** : -1.5V(Min.) when pulse width of undershoot is less than 10ns.

AC Characteristics

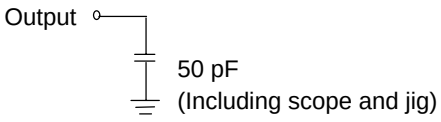
(V_{CC} = 3.3 V ± 0.3 V, Ta = 0 to 70°C)

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	t_C	—	100	—	ns
Address access time	t_{ACC}	CE# = OE# = V_{IL}	—	100	ns
Page cycle time	t_{PC}	—	30	—	ns
Page access time	t_{PAC}	CE# = OE# = V_{IL}	—	30	ns
CE# access time	t_{CE}	OE# = V_{IL}	—	100	ns
OE# access time	t_{OE}	CE# = V_{IL}	—	30	ns
Output disable time	t_{CHZ}	OE# = V_{IL}	0	20	ns
	t_{OHZ}	CE# = V_{IL}	0	20	ns
Output hold time	t_{OH}	CE# = OE# = V_{IL}	0	—	ns

Measurement conditions

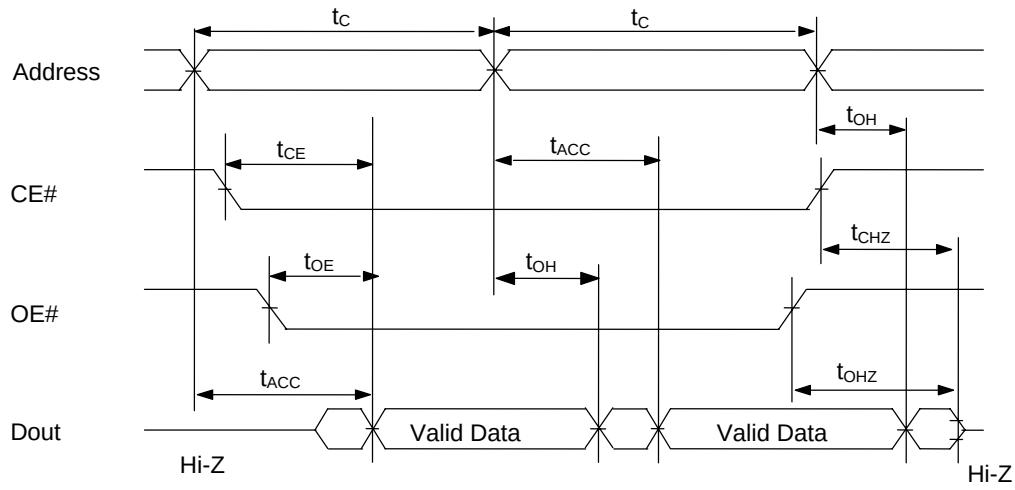
Input signal level 0 V/3 V
Input timing reference level 1/2Vcc
Output load 50 pF
Output timing reference level 1/2Vcc

Output load

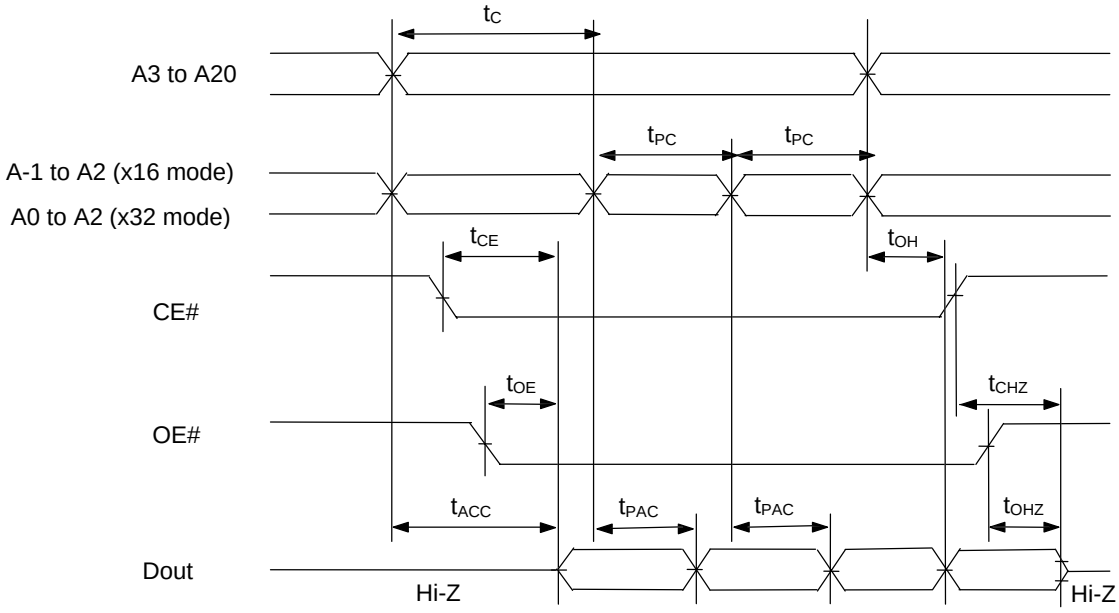


TIMING CHART (READ CYCLE)

Random Access Mode Read Cycle



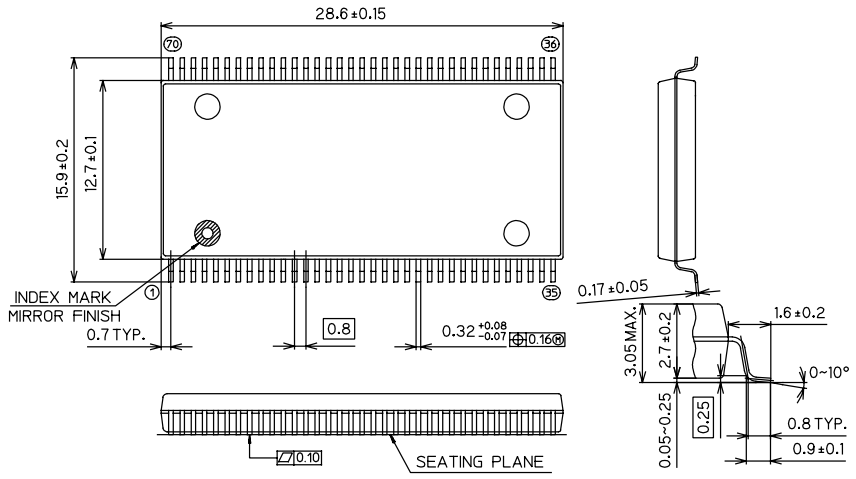
Page Access Mode Read Cycle



PACKAGE DIMENSIONS

(Unit: mm)

P-SSOP70-500-0.80-K-MC



Package material	Epoxy resin
Lead frame material	42 alloy
Pin treatment	Solder plating (≥5μm)
Package weight (g)	2.15 TYP.
Rev. No./Last Revised	1/Nov. 13, 2002

Oki Electric Industry Co., Ltd.

Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.
Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

REVISION HISTORY

Document No.	Date	Page		Description
		Previous Edition	Current Edition	
FEDR26V6455J-02-01	Oct.30, 2007	–	–	Final edition 1

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